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[US6214133](#)

Two phase titanium aluminide alloy
PHILIP MORRIS

[WO9951787](#)

Two phase titanium aluminide alloy
CHRYSALIS TECHNOLOGIES CHRYSA LIS TECHNOLOGY PHILIP
MORRIS

[WO200233138](#)

Creep resistant titanium aluminide alloys
CHRYSALIS TECHNOLOGIES CHRYSA LIS TECHNOLOGY PHILIP
MORRIS

Claims

(US6214133)

What is claimed is:

1.

A two phase Cr-free and Mu-free titanium aluminide alloy consisting essentially of, in weight %, 50 to 65% Ti, 25 to 35% Al, 2 to 15% Nb, less than 5% Mo, 1 to 10% W, and 0.01 to 0.2% B.

2. The titanium aluminide alloy of claim 1, in an as-cast, hot extruded, cold worked, or heat treated condition.

3. The titanium aluminide alloy of claim 1, wherein the alloy has a two-phase lamellar microstructure with fine particles are located at colony boundaries.

4. The titanium aluminide alloy of claim 3, wherein fine boride particles are located at the colony boundaries.

5. The titanium aluminide alloy of claim 3, wherein fine second-phase particles are located at the colony boundaries.

6. The titanium aluminide alloy of claim 1, wherein the alloy has a two-phase microstructure including grain-boundary equiaxed structures.

7. The titanium aluminide alloy of claim 1, wherein the Ti content is 57 to 60%, the Al content is 30 to 32%, the Nb content is 4 to 9%, the Mo content is at most 2%, the W content is 2 to 8% and the B content is 0.02 to 0.08%.

8. The titanium aluminide alloy of claim 1, having a yield strength of more than 80 ksi (560 MPa), an ultimate tensile strength of more than 90 ksi (680 MPa) and/or tensile elongation of at least 1%.

9. The titanium aluminide alloy of claim 1, wherein the alloy has a microstructure in which W is distributed non-uniformly.

10. The titanium aluminide alloy of claim 1, wherein aluminum is present in an amount of about 46 to 47 atomic %.

11. The titanium aluminide alloy of claim 1, wherein the alloy has a lamellar microstructure substantially free of equiaxed structures at colony boundaries.

12. The titanium aluminide alloy of claim 1, wherein the alloy does not include Mo.

13. The titanium aluminide alloy of claim 1, wherein the Ti content is 57 to 60%, the Al content is 30 to 32%, the Nb content is 4 to 9%, the W content is 2 to 8% and the B content is 0.02 to 0.08%.

14. The titanium aluminide alloy of claim 1, including 45 to 55 at % Ti, 40 to 50 at % Al, 1 to 5 at % Nb, 0.3 to 1.5 at % W, and 0.1 to 0.3 at % B.

15. The titanium aluminide alloy of claim 1, comprising a sheet with a thickness of 8 to 30 mils.

16. The titanium aluminide alloy of claim 1, free of Cr, V, Co, Cu and Ni.

17. The titanium aluminide alloy of claim 1, comprising TiAl with 2 to 4 at % Nb, ≤ 1 at % Mo and 0.5 to 2 at % W, 0.1 to 0.3 at % B.

18. The titanium aluminide alloy of claim 1, including 1 to 4 at % Nb, ≤ 1 at % Mo and 0.25 to 2 at % W.

19. The titanium aluminide alloy of claim 1, wherein the alloy has been formed into an electrical resistance heating element capable of heating to 900 (degree) C. in less than 1 second when a voltage of up to 10 volts and up to 6 amps is passed through the heating element.

Two phase titanium aluminide alloy WO9951787

<ul style="list-style-type: none"> • Patent Assignee CHRYSLIS TECHNOLOGIES CHRYSLIS TECHNOLOGY PHILIP MORRIS • Inventor DEEVI SEETHARAMA C LIU C T • International Patent Classification B22F-003/23 C22C-001/04 C22C-014/00 C22C-029/00 C22C-032/00 C22F-001/18 • CPC Code B22F-003/23; B22F-2998/10; C22C-001/04/58; C22C-001/04/91; C22C-014/00; C22C-029/00/5; C22C-032/00; C22F-001/18/3 	<ul style="list-style-type: none"> • Publication Information WO9951787 A1 1999-10-14 [WO9951787] <div style="text-align: right;">  </div> <ul style="list-style-type: none"> • Priority Details 1998US-09017483 1998-02-02 1998US-09174103 1998-10-16 1999WO-US02212 1999-02-02 2000KR-7008448 2000-08-02 																																																																																																				
<ul style="list-style-type: none"> • Fampat family <table style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 30%;">WO9951787</td> <td style="width: 15%;">A1</td> <td style="width: 15%;">1999-10-14</td> <td style="width: 40%;">[WO9951787]</td> </tr> <tr> <td>CA2319505</td> <td>A1</td> <td>1999-10-14</td> <td>[CA2319505]</td> </tr> <tr> <td>AU5078399</td> <td>A</td> <td>1999-10-25</td> <td>[AU9950783]</td> </tr> <tr> <td>WO9951787</td> <td>A9</td> <td>2000-06-22</td> <td>[WO9951787]</td> </tr> <tr> <td>NO20003891</td> <td>D0</td> <td>2000-07-28</td> <td>[NO200003891]</td> </tr> <tr> <td>NO20003891</td> <td>A</td> <td>2000-10-02</td> <td>[NO200003891]</td> </tr> <tr> <td>BR9908529</td> <td>A</td> <td>2000-12-05</td> <td>[BR9908529]</td> </tr> <tr> <td>ID26231</td> <td>A</td> <td>2000-12-07</td> <td>[ID--26231]</td> </tr> <tr> <td>EP1066415</td> <td>A1</td> <td>2001-01-10</td> <td>[EP1066415]</td> </tr> <tr> <td>CN1292038</td> <td>A</td> <td>2001-04-18</td> <td>[CN1292038]</td> </tr> <tr> <td>EP1066415</td> <td>A4</td> <td>2001-05-09</td> <td>[EP1066415]</td> </tr> <tr> <td>KR20010040579</td> <td>A</td> <td>2001-05-15</td> <td>[KR20010040579]</td> </tr> <tr> <td>JP2002510750</td> <td>A</td> <td>2002-04-09</td> <td>[JP2002510750]</td> </tr> <tr> <td>EP1066415</td> <td>B1</td> <td>2002-07-24</td> <td>[EP1066415]</td> </tr> <tr> <td>AT221137</td> <td>T</td> <td>2002-08-15</td> <td>[ATE221137]</td> </tr> <tr> <td>DE69902245</td> <td>D1</td> <td>2002-08-29</td> <td>[DE69902245]</td> </tr> <tr> <td>AU751819</td> <td>B2</td> <td>2002-08-29</td> <td>[AU-751819]</td> </tr> <tr> <td>CN1100153</td> <td>C</td> <td>2003-01-29</td> <td>[CN1100153C]</td> </tr> <tr> <td>DE69902245</td> <td>T2</td> <td>2003-03-27</td> <td>[DE69902245]</td> </tr> <tr> <td>KR100641905</td> <td>B1</td> <td>2006-11-06</td> <td>[KR100641905]</td> </tr> <tr> <td>IN0238/CHENP/2000</td> <td>A</td> <td>2007-04-27</td> <td>[IN2000CN00238]</td> </tr> <tr> <td>IN216237</td> <td>B</td> <td>2008-03-31</td> <td>[IN-216237]</td> </tr> <tr> <td>CA2319505</td> <td>C</td> <td>2009-10-06</td> <td>[CA2319505]</td> </tr> <tr> <td>JP4664500</td> <td>B2</td> <td>2011-04-06</td> <td>[JP4664500]</td> </tr> <tr> <td>NO333617</td> <td>B1</td> <td>2013-07-22</td> <td>[NO-333617]</td> </tr> </table>		WO9951787	A1	1999-10-14	[WO9951787]	CA2319505	A1	1999-10-14	[CA2319505]	AU5078399	A	1999-10-25	[AU9950783]	WO9951787	A9	2000-06-22	[WO9951787]	NO20003891	D0	2000-07-28	[NO200003891]	NO20003891	A	2000-10-02	[NO200003891]	BR9908529	A	2000-12-05	[BR9908529]	ID26231	A	2000-12-07	[ID--26231]	EP1066415	A1	2001-01-10	[EP1066415]	CN1292038	A	2001-04-18	[CN1292038]	EP1066415	A4	2001-05-09	[EP1066415]	KR20010040579	A	2001-05-15	[KR20010040579]	JP2002510750	A	2002-04-09	[JP2002510750]	EP1066415	B1	2002-07-24	[EP1066415]	AT221137	T	2002-08-15	[ATE221137]	DE69902245	D1	2002-08-29	[DE69902245]	AU751819	B2	2002-08-29	[AU-751819]	CN1100153	C	2003-01-29	[CN1100153C]	DE69902245	T2	2003-03-27	[DE69902245]	KR100641905	B1	2006-11-06	[KR100641905]	IN0238/CHENP/2000	A	2007-04-27	[IN2000CN00238]	IN216237	B	2008-03-31	[IN-216237]	CA2319505	C	2009-10-06	[CA2319505]	JP4664500	B2	2011-04-06	[JP4664500]	NO333617	B1	2013-07-22	[NO-333617]
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- **Abstract:**

(EP1066415)

A two phase titanium aluminide alloy having a lamellar microstructure with little intercolony structures. The alloy can include fine particles such as boride particles at colony boundaries and/or grain boundary equiaxed structures. The alloy can include alloying additions such as ≤ 10 at % W, Nb and/or Mo. The alloy can be free of Cr, V, Mn, Cu and/or Ni and can include, in atomic %, 45 to 55 % Ti, 40 to 50 % Al, 1 to 5 % Nb, 0.3 to 2 % W, up to 1 % Mo and 0.1 to 0.3 % B. In weight %, the alloy can include 57 to 60 % Ti, 30 to 32 % Al, 4 to 9 % Nb, up to 2 % Mo, 2 to 8 % W and 0.02 to 0.08 % B. (From WO9951787 A1)

Claims

(EP1066415)

1. A two-phase titanium aluminide alloy consisting of, in weight %, 50 to 65% Ti, 25 to 35% Al, 2 to 15 %Nb, less than 5%Mo, 1 to 10% W, and 0.01 to 0.2% B.
2. The titanium aluminide alloy of Claim 1, in an as-cast, hot extruded, cold worked, or heat treated condition.
3. The titanium aluminide alloy of Claim 1, wherein the alloy has a two-phase lamellar microstructure with fine particles are located at colony boundaries.
4. The titanium aluminide alloy of Claim 3, wherein fine boride particles are located at the colony boundaries.
5. The titanium aluminide alloy of Claim 3, wherein fine second-phase particles are located at the colony boundaries.
6. The titanium aluminide alloy of Claim 1, wherein the alloy has a two-phase microstructure including grain-boundary equiaxed structures.
7. The titanium aluminide alloy of Claim 1, wherein the Ti content is 57 to 60%, the Al content is 30 to 32%, the Nb content is 4 to 9%, the Mo content is at most 2%, the W content is 2 to 8% and the B content is 0.02 to 0.08%.
8. The titanium aluminide alloy of Claim 1, having a yield strength of more than 80 ksi (560 MPa), an ultimate tensile strength of more than 90 ksi (680 MPa) and/or tensile elongation of at least 1%.
9. The titanium aluminide alloy of Claim 1, wherein the alloy has a microstructure in which W is distributed non-uniformly.
10. The titanium aluminide alloy of Claim 1, wherein aluminum is present in an amount of about 46 to 47 atomic %.
11. The titanium aluminide alloy of Claim 1, wherein the alloy has a lamellar microstructure substantially free of equiaxed structures at colony boundaries.
12. The titanium aluminide alloy of Claim 1, wherein the alloy does not include Mo or Cr.
13. The titanium aluminide alloy of Claim 1, wherein the Ti content is 57 to 60%, the Al content is 30 to 32%, the Nb content is 4 to 9%, the W content is 2 to 8% and the B content is 0.02 to 0.08%.
14. The titanium aluminide alloy of Claim 1, including 45 to 55 at% Ti, 40 to 50 at% Al, 1 to 5 at% Nb, 0.3 to 1.5 at% W, and 0.1 to 0.3 at% B.
15. The titanium aluminide alloy of Claim 1, comprising a sheet with a thickness of 8 to 30 mils.
16. The titanium aluminide alloy of Claim 1, free of Cr, V, Mn, Co, Cu and Ni.
17. The titanium aluminide alloy of Claim 1, comprising TiAl with 2 to 4 at% Nb, <= 1 at% Mo and 0.5 to 2 at% W, 0.1 to 0.3 at% B.
18. The titanium aluminide alloy of Claim 1, including 1 to 4 at% Nb, <= 1 at% Mo and 0.25 to 2 at% W.
19. The titanium aluminide alloy of Claim 1, wherein the alloy has been formed into an electrical resistance heating element capable of heating to 900 DEG.C in less than 1 second when a voltage of up to 10 volts and up to 6 amps is passed through the heating element.

Creep resistant titanium aluminide alloys

WO200233138

<ul style="list-style-type: none"> • Patent Assignee CHRYSLIS TECHNOLOGIES CHRYSLIS TECHNOLOGY PHILIP MORRIS • Inventor DEEVI SEETHARAMA C ZHANG WEI-JUN • International Patent Classification B22F-003/23 C22C-001/04 C22C-014/00 C22C-029/00 C22C-032/00 C22F-001/18 • CPC Code B22F-003/23; B22F-2998/10; C22C-001/04/58; C22C-001/04/91; C22C-014/00; C22C-029/00/5; C22C-032/00; C22F-001/18/3 	<ul style="list-style-type: none"> • Publication Information WO200233138 A1 2002-04-25 [WO200233138]     • Priority Details 2000US-09660961 2000-09-13 2001WO-US26329 2001-08-23 																								
<ul style="list-style-type: none"> • Fampat family <table style="width: 100%; border: none;"> <tr> <td style="width: 30%;">WO200233138</td> <td style="width: 20%;">A1</td> <td style="width: 20%;">2002-04-25</td> <td style="width: 30%;">[WO200233138]</td> </tr> <tr> <td>AU3037902</td> <td>A</td> <td>2002-04-29</td> <td>[AU200230379]</td> </tr> <tr> <td>TW500807</td> <td>B</td> <td>2002-09-01</td> <td>[TW-500807]</td> </tr> <tr> <td>EP1322792</td> <td>A1</td> <td>2003-07-02</td> <td>[EP1322792]</td> </tr> <tr> <td>WO200233138</td> <td>A9</td> <td>2003-08-21</td> <td>[WO200233138]</td> </tr> <tr> <td>EP1322792</td> <td>A4</td> <td>2006-05-31</td> <td>[EP1322792]</td> </tr> </table> 		WO200233138	A1	2002-04-25	[WO200233138]	AU3037902	A	2002-04-29	[AU200230379]	TW500807	B	2002-09-01	[TW-500807]	EP1322792	A1	2003-07-02	[EP1322792]	WO200233138	A9	2003-08-21	[WO200233138]	EP1322792	A4	2006-05-31	[EP1322792]
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EP1322792	A4	2006-05-31	[EP1322792]																						

- **Abstract:**

(WO200233138)

A creep resistant titanium aluminide alloy having fine particles such as boride particles at colony boundaries and/or grain boundary equiaxed structures. The alloy can include alloying additions such as ≤ 10 at % W, Nb and/or Mo. The alloy can be free of Cr, V, Mn, Cu and/or Ni and can include, in atomic %, 45 to 55 % Ti, 40 to 50 % Al, 1 to 10 % Nb, 0.1 to 2 % W, up to 1 % Mo and 0.1 to 0.8 % B or the alloy can include, in weight %, 50 to 65 % Ti, 25 to 35 % Al, 2 to 20 % Nb, up to 5 % Mo, 0.5 to 10 % W and 0.01 to 0.5 % B. (From WO200233138 A9)

Claims

(WO200233138)

WHAT IS CLAIMED IS : 1. A titanium aluminide alloy consisting essentially of, in %, 50 to 65% Ti, 25 to 35% Al, 2 to 20 % Nb, 0.5 to 10% W and/or Ta, and 0.01 to 0.5% B.

2. The titanium aluminide alloy of Claim 1, in an as-cast, hot extruded, cold worked, or heat treated condition.

3. The titanium aluminide alloy of Claim 1, wherein the alloy has a two-phase nearly fully lamellar microstructure with fine particles are located at colony boundaries.

4. The titanium aluminide alloy of Claim 1, wherein fine boride particles are located at the colony boundaries.

5. The titanium aluminide alloy of Claim 4, wherein fine second-phase particles are located at the colony boundaries.

6. The titanium aluminide alloy of Claim 1, wherein the alloy has a two-phase microstructure including grain-boundary equiaxed structures.

7. The titanium aluminide alloy of Claim 1, wherein the Al content is 45 to 47 atomic %, the Nb content is 4 to 10 atomic %, the W content is 0.1 to 0.8 atomic % and the B content is 0.02 to 0.8 atomic %.

8. The titanium aluminide alloy of Claim 1, having a yield strength of more than 80 ksi (560 MPa), an ultimate tensile strength of more than 90 ksi (680 MPa) and/or tensile elongation of at least 1 %.

9. The titanium aluminide alloy of Claim 1, wherein the alloy has a microstructure in which W is distributed non-uniformly.

10. The titanium aluminide alloy of Claim 1, wherein aluminum is present in an amount of about 46 to 47 atomic %.

11. The titanium aluminide alloy of Claim 1, wherein the alloy has a lamellar microstructure substantially free of equiaxed structures at colony boundaries.

12. The titanium aluminide alloy of Claim 1, wherein the alloy does not include Mo or Cr.

13. The titanium aluminide alloy of Claim 1, wherein the Al content is 46 to 48 atomic %, the Nb content is 7 to 9 atomic %, the W content is 0.1 to 0.6 atomic % and the B content is 0.04 to 0.6 atomic%.

14. The titanium aluminide alloy of Claim 1, including 45 to 55 at% Ti, 40 to 50 at% Al, 1 to 10 at% Nb, 0.1 to 1.5 at% W, and 0.05 to 0.5 at% B.

15. The titanium aluminide alloy of Claim 1, comprising a sheet with a thickness of 8 to 30 mils.

16. The titanium aluminide alloy of Claim 1, free of Cr, V, Mn, Co, Cu and Ni.

17. The titanium aluminide alloy of Claim 1, comprising TiAl with 6 to 10 at% Nb, 0.2 to 0.5 at% W, and 0.05 to 0.5 at% B.

18. The titanium aluminide alloy of Claim 1, including 1 to 9 at% Nb, s 1 at% Mo and 0.2 to 2 at% W.

19. The titanium aluminide alloy of Claim 1, wherein the alloy exhibits a creep rate of less than about 5×10^{-10} under a stress of 100 MPa.

20. The titanium aluminide alloy of Claim 1, wherein the alloy exhibits a creep rate of less than about 10^{-9} under a stress of 150 MPa.

21. The titanium aluminide alloy of Claim 1, wherein the alloy exhibits a creep rate of less than about 10^{-8} under a stress of 200 MPa.

22. The titanium aluminide alloy of Claim 1, wherein the alloy exhibits a time to 0.5% creep strain of at least 1000 hours under a stress of 140 Mpa and temperature of 760 C.